ASSOCIATION CONNECTION ELECTRONICS INDUSTRIE	Material Comp © Copyright 2005. I international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lowel level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Form Typ				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						erials and M	ials and Mfg Information				
Supplier Inform	nation																
Company name* Company t			Company un	mpany unique ID			Unique ID Authority					Respons	Response Date*				
onsemi													2025-07-05				
Contact Name		Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*					
Product-Env-Stew	ards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com					
Authorized Repres	entative*	Title - Representative]	Phone - Representative*				Email -	Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance				NA				Produc	Product-Env-Stewards@onsemi.com					
Request	er Item Number	Item Number Mfr Item Nu FAN7171M		tem Number Mfr Item Name			Effective Da	ate V	Version	rsion Manufacturing Site			Weight*		UOM	Unit Type	
				MX-F085 High Volt Gate Driver SO8			2025-07-05		TH2			80.792		mg	Each		
Ianufacturing	Proccess Informa	tion															
Terminal	Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 M	D-020 MSL Rating		Peak Process Body Temperature		ure M	re Max Time at Peak Temper		ature Number of Reflow Cycles		les		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 3		3		260		С		30 seco		nds	3			
Comments																	
TTENTION: MS	L 3 Rated item require	s Bake and I	Ory Pack (afte	r electrical test)													
or more informati	on regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier is liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.16	mg	Supplier	Silicon (Si)	7440-21-3		2.16	mg
Die Attach	1.144	mg	Supplier	Silver (Ag)	7440-22-4		0.8466	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.2974	mg
Lead Frame	31.136	mg	Supplier	Zinc (Zn)	7440-66-6		0.0374	mg
			Supplier	Iron (Fe)	7439-89-6		0.7286	mg
			Supplier	Copper (Cu)	7440-50-8		30.3451	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0249	mg
Mold Compound	45.29	mg	Supplier	Trimethoxysilylpropanethiol	4420-74-0		0.2264	mg
			Supplier	Boron zinc hydroxide oxide	138265-88-0		0.2264	mg
			Supplier	2,4,6-triamino-s-triazincompd.withs-triazine-triol	37640-57-6		2.2645	mg
			Supplier	Silica Amorphous (SiO2)	7631-86-9		2.2645	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		40.0816	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.2264	mg
Plating	0.435	mg	Supplier	Silver (Ag)	7440-22-4		0.0066	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0154	mg
			В	Nickel (Ni)	7440-02-0		0.404	mg
			Supplier	Gold (Au)	7440-57-5		0.009	mg
Wire Bond - Au	0.627	mg	Supplier	Gold (Au)	7440-57-5		0.627	mg